



Needs And Requirements for Microelectronics From the Acquisition Community



Office of the Assistant Secretary of Defense for Industrial Base Policy

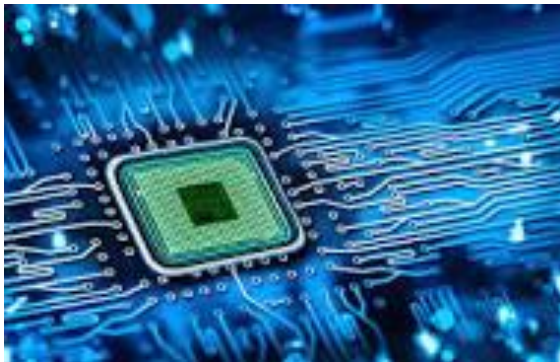
Controlled by: OUSD(A&S)/Industrial Base Policy (IBP)
CUI Category: None
Distribution Statement A
POC: Dr. Christine Michienzi, CTO OUSD (A&S)/ASD IBP
Distribution Statement A: Approved for public release.
Distribution Unlimited



Agenda



- OUSD (A&S) Microelectronics (ME) Overview
- ME Acquisition Challenges
- Requirements for ME used in DoD applications
- Strategies to Increase Utilization of Modern COTS ME in DoD





OUSD (A&S) Microelectronics Overview



- Emphasis is on sustainment of existing DoD systems
 - More emphasis on State of the Practice (SOTP) and legacy semiconductor technologies
 - State of the Art (SOTA) technology development supported by investment and collaboration within DoD and with industry
 - Technology development is prioritized by OUSD (R&E)
- Leverage DoD investment authorities to resolve critical ME sustainment issues
 - Access to more modern radiation-hardened semiconductor technologies
 - Access to technologies with little commercial viability – SOTP, DoD unique, classified
- Close collaboration with OUSD (R&E) and DMCFT
 - Collaborate with OUSD (R&E) on multiple ME policy initiatives
 - Participation as core members of Defense Microelectronics Cross-Functional Team (DMCFT)
- Close collaboration with interagency on CHIPS Act – particularly National Security Council and Department of Commerce



Microelectronics Acquisition Challenges



- DoD is a low volume, high mix customer for ME
 - Commercial ME sector is predicated on high volume production
 - Low volume need implies DoD has very limited market presence in ME (<1%)- limited ability to drive change
 - Previous use of dedicated or split fabs not sustainable
- Extended life cycle of DoD Systems
 - DoD systems are often fielded for multiple decades
 - DoD typically designs with SOTA parts, but by the time systems are fielded (10-15 yrs), they're already obsolete
 - Then DoD keeps those systems in the field for 15-30 yrs
 - Commercial ME technologies change every 2.5 years
 - DoD is out-of-phase and multiple generations behind commercially viable ME technologies
 - It is difficult for DoD to perform technology refreshes on existing systems
- DoD specific ME applications are not commercially sustainable
 - Strategic radiation hardened microelectronics – space, nuclear applications
 - Ultra-High voltage (>25kV) power electronics – switching modules (improves SWaP) and fuze applications (increases stand-off distances)
 - Classified designs



DoD Microelectronics Requirements



- DoD Requires assured, secure ME
 - Most commercial ME components lack provenance, and are manufactured in unsecure environments
 - Majority of these components are manufactured outside the United States
- Harsh environment operation (High temp, Radiation..)
 - COTS ME typically designed to operate in constrained temperature ranges (Typically 0°C-70°C for commercial grades)
 - DoD applications often require parts to operate in harsh environments with extended temperature ranges (-55°C-125°C), or in irradiated environments (space, nuclear)
- Quantified reliability
 - Many DoD applications are mission and safety-critical
 - Commercial ME reliability data and quantification methods are incomplete, or often completely unknown





Strategies to Increase Use of Commercial Microelectronics



- Develop and implement assurance methodologies that are independent of manufacturer's geographic location
 - Almost all SOTA COTS components are manufactured overseas
 - Need assurance and security strategies that accommodate this
 - Current DoD Trusted Supplier Network does not cover SOTA semiconductor fabrication or OCONUS manufacturing
 - No "one size fits all" solution – DoD requires multiple options
- Develop DoD COTS implementation strategy
 - COTS utilization in DoD critical applications requires a reliability quantification strategy be developed
 - Collaborate with industry to develop standards for commercial ME products used in DoD applications
- Streamline acquisition policies
 - DoD needs to better utilize tools like digital engineering and modular open systems architecture to allow for technology refreshes
 - Allows programs to maintain parity with commercial sector technology